## 506196301 08/10/2020

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
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JONGBO SHIM	07/13/2020
HWANPIL PARK	07/13/2020
JANGWOO LEE	07/13/2020

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#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16928159

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ATTORNEY DOCKET NUMBER:	SAM-58170
NAME OF SUBMITTER:	ALYSA N. YOUNGSON
SIGNATURE:	/Alysa N. Youngson/
DATE SIGNED:	08/10/2020

## **Total Attachments: 4**

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# HH Ref.: SPD190099-US; COMBINED DECLARATION (37 CFR § 1.63) FOR UTILITY PATENT APPLICATION AND ASSIGNMENT FORM<sup>1</sup>

The undersigned acknowledges that this document is being used both as an assignment of the invention and as the declaration (37 CFR § 1.63) for a Utility or Design Application.

WHEREAS, the undersigned, hereinafter referred to individually and collectively as Assignor, has invented:

Title:	SEMICONDUCTOR PACKAGES HAVING	A DAM STRUCTURE
for which A for patent.	Assignor is about to make or has made United Sta	ates or International application
WHEREAS,	, as a below named inventor(s), I/(we) hereby dec	clare that:
Section I. I	Declaration	
This declar	ration is directed to:	
$\boxtimes$	The attached U.S. non-provisional patent ap	olication, or
	U.S. non-provisional patent application num, or	ber, filed on
	PCT international patent application number	·, filed on
	·	
The above-	identified application was made or authorized to	be made by me (us).
	eve that I am (we are) the original inventor (origin the above-identified application.	ginal joint inventors) of a claimed
	reby acknowledge that any willful false stateme under 18 U.S.C. § 1001 by fine or imprisonmen	
	eby state that I (we) have reviewed and under application, including the claims.	stand the contents of the above
	nowledge that I (we) am (are) aware of the duty o patentability as defined in 37 C.F.R. § 1.56.	to disclose information which is
<sup>1</sup> This form r	requires the use of an Application Data Sheet.	
SEC Ref No.	. <u>II-201910-032-1-US0</u> Attorney	Ref No. <b>SAM-58170</b>
COMBINED	DECLARATION (37 CFR 1.63) FOR UTILITY PATENT AP	PLICATION AND ASSIGNMENT FORM

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PATENT REEL: 053447 FRAME: 0534

#### Section II. Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned hereby sell(s) and assign(s) to

#### Samsung Electronics Co., Ltd.

having an address at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do 16677, Republic of Korea (hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 U.S.C. § 100, in the invention described in the application identified in Section I of this document.

Assignor hereby confirms any prior assignment to Assignee, and to the extent that Assignor has not already done so, agrees to assign, and hereby does, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, reexamination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

Assignor hereby covenants that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

Assignor hereby requests the United States Patent and Trademark Office to issue the Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue the Letters Patent, Utility Model Registration or other similar right to Assignee.

SEC Ret No.	11-201910-032-1-US0	Attorney Ref No	SAM-58170	

The undersigned hereby grant(s) the law firm of Muir Patent Law, PLLC the power to insert on this Declaration and Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

# Section III. Inventor(s)/Assignor(s) Signature(s)

LEGAL NAME OF	Family Name	First Given Name	Second Given Name
FIRST INVENTOR/ASSIGNOR	KIM	Dongho	
SIGNATURE		DATE	2-2- 7.13

LEGAL NAME OF	Family Name	First Given Name	Second Given Name
SECOND INVENTOR/ASSIGNOR	SHIM	Jangbo	
V			
Pool SIGNATURE	ndry 1934 Auguris Pil		2020, 1, 13

LEGAL NAME OF	Family Name	First Given Name	Second Given Name
THIRD -	PARK	Hwanpil	
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SIGNATURE /	MARY	DATE	
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SEC Ref No.	II-201910-032-1-US0	Attorney Ref No.	SAM-58170
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SAMSUNG ELECTRONICS CO., LTD.

FOURTH LEE Jangwoo INVENTOR/ASSIGNOR	LEGAL NAME OF	Family Name	First Given Name	Second Given Name
		LEE	Jangwoo	)
			<u> </u>	
SIGNATURE //// DATE 3010 1/3				

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